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PATENT  
EXPRESS MAIL NO. EV322526295US  
Attorney Docket No. A54  
Client/Matter No. 80741.0026.001

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of: Tapesh Yadav, et al.

Serial No.: 10/071,027

Filed: February 8, 2002

For: **ENGINEERING RAW  
MATERIALS FOR  
NANOMATERIALS  
TECHNOLOGY (as amended)**

**PRECURSORS OF ENGINEERED  
POWDERS(as filed)**

Art Unit: 1742

Examiner: G. WYSZOMIERSKI

**EXPEDITED PROCEDURE  
UNDER 37 CFR 1.116**

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Sir:

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- Amendment and Response (5 pages);
- References (9 pages)
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relating to the above application, were deposited as "Express Mail", Mailing Label No. EV322528384US with the United States Postal Service, addressed to The Commissioner for Patents, Washington, D.C., 20231, on November 3, 2003.

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**AMENDMENT AND RESPONSE**

Sir:

In response to the Office Action mailed September 05, 2003, please reconsider the above-identified patent application in view of the amendments and remarks presented hereinafter.